SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Reverse Capacitance
- Ultra-Small Surface Mount Package
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability (Only for SD103AWS-7-F)

Mechanical Data

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Leads: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.004 grams (approximate)

Top View

Maximum Ratings @T_A = 25℃ unless otherwise specified

Characteristic		Symbol	SD103AWS	SD103BWS	SD103CWS	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	40	30	20	>
RMS Reverse Voltage		V _{R(RMS)}	28	21	14	V
Forward Continuous Current (Note 1)		I_{FM}		350		mA
Non-Repetitive Peak Forward Surge Current	@ t ≤ 1.0s	I_{FSM}		1.5	•	Α

Thermal Characteristics

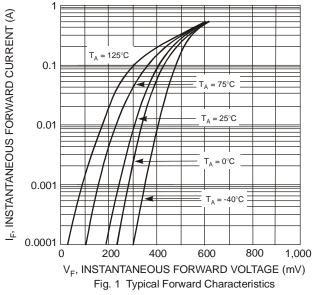
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-65 to +125	°C

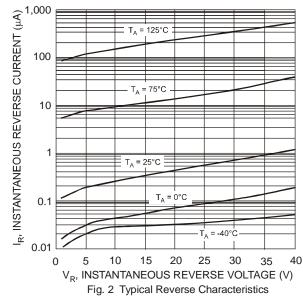
Electrical Characteristics $@T_A = 25\%$ unless otherwise specified

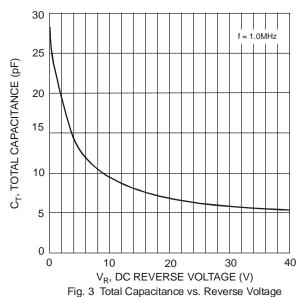
Characteristic		Symbol	Min	Тур	Max	Unit	Test Conditions
SD103AWS Reverse Breakdown Voltage (Note 2)	SD103BWS SD103CWS	V _{(BR)R}	40 30 20	_	_	V	$\begin{split} I_R &= 100 \mu A \\ I_R &= 100 \mu A \\ I_R &= 100 \mu A \end{split}$
Forward Voltage Drop		V _F	_	_	0.37 0.60	V	I _F = 20mA I _F = 200mA
SD103AWS Peak Reverse Current (Note 2)	SD103BWS SD103CWS	I _R			5.0	μА	$V_R = 30V$ $V_R = 20V$ $V_R = 10V$
Total Capacitance		Ст	_	28	_	pF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time		t _{rr}		10	_	ns	$I_F = I_R = 200 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

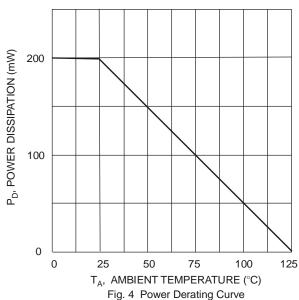
Notes:

- 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration test pulse used to minimize self-heating effect.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Čode V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.







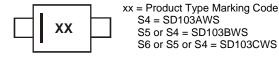


Ordering Information (Note 5)

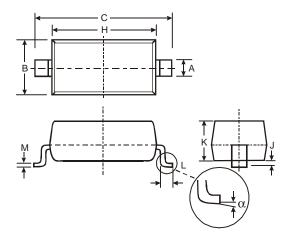
Part Number	Case	Packaging
SD103AWS-7-F	SOD-323	3000/Tape & Reel
SD103BWS-7-F	SOD-323	3000/Tape & Reel
SD103CWS-7-F	SOD-323	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

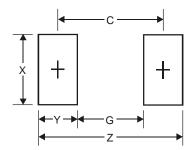


Package Outline Dimensions



SOD-323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
С	2.30	2.70		
Н	1.60	1.80		
J	0.00	0.10		
K	1.0	1.1		
L	0.20	0.40		
M	0.10	0.15		
α	0°	8°		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.75
G	1.05
Х	0.65
Y	1.35
С	2.40

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